Rev. 1.1, 23.02.2020

SMB1N-980D-02

- Infrared High Power LED
- 980 nm, 400 mW
- SMD package, PA9T
- Dimension: 5.0 x 5.2 x 5.5 mm
- Viewing Angle: 20°



Description



SMB1N-980D is a surface mount AlGaAs High Power LED with a typical peak wavelength of **980 nm** and radiation of **400 mW**. It comes in SMD package (PA9T) with silver plated soldering pads (lead free solderable), copper heat sink, and molded with silicone resin.

Maximum Ratings (TCASE=25°C)

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Parameter	Symbol	Min.	Max.	Unit	
Power Dissipation	PD		2000	mW	
Forward Current	IF		1000	mA	
Pulse Forward Current *1	IFP		3000	mA	
Reverse Voltage	V _R		5	V	
Thermal Resistance	RTHJA		10	K/W	
Junction Temperature	TJ		120	°C	
Operating Temperature	TCASE	- 40	+ 100	°C	
Storage Temperature	T _{STG}	- 40	+ 100	°C	
Lead Solder Temperature *2	T _{SLD}		+ 250	°C	

^{*1} duty=1%, pulse width = 10 µs

Electro-Optical Characteristics (TCASE=25°C)

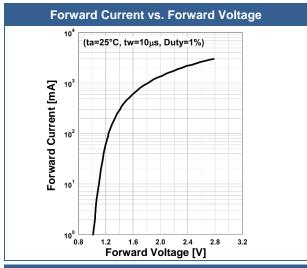
Parameter	Symbol	Conditions	Min.	Values Typ.	Max.	Unit
Peak Wavelength	λ_P	I _F =800mA	960		1000	nm
Half Width	$\Delta \lambda$	I _F =800mA		60		nm
Forward Voltage	V _F	I _F =800mA		1.7	(2.0)	V
	V_{FP}	I _{FP} =3A		2.8		
Radiated Power *1	Po	I _F =800mA		400		mW
		I _{FP} =3A		1300		
Radiant Intensity *2	I _E	I _F =800mA		1900		mW/sr
		I _{FP} =3A		6300		
Viewing Angle	φ	I _F =100mA		20		deg.
Rise Time	t_R	I _F =800mA		35		ns
Fall Time	tϝ	I _F =800mA		30		ns

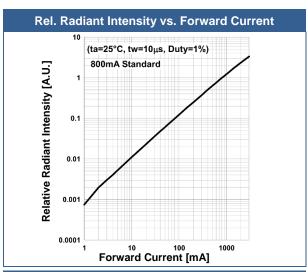
^{*1} measured by S3584-08

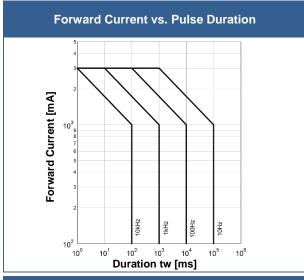
^{*2} must be completed within 5 seconds

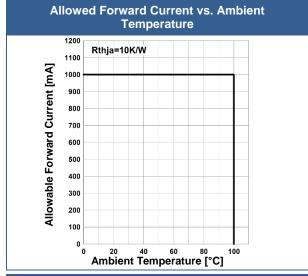
^{*2} measured by CIE127-2007 Condition B

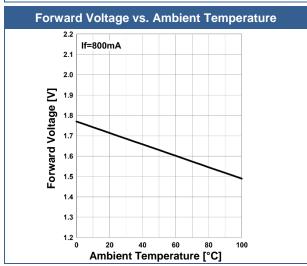
Typical Performance Curves

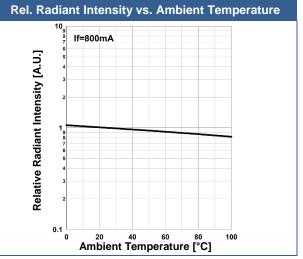










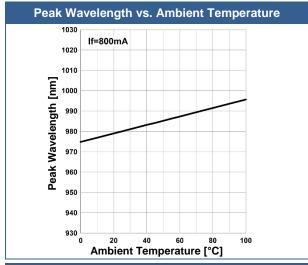


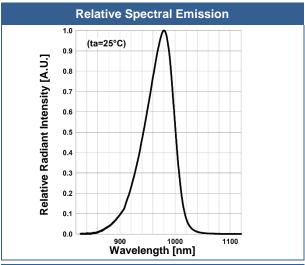


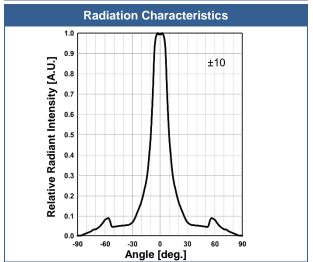
ROITHNER LASERTECHNIK GmbH

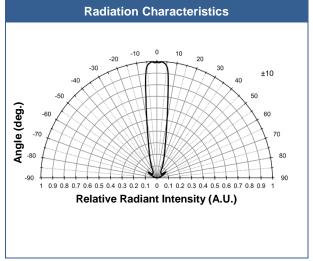
WIEDNER HAUPTSTRASSE 76 IO40 VIENNA AUSTRIA TEL. +43 I 586 52 43 -0, FAX. -44 OFFICE@ROITHNER-LASER.COM



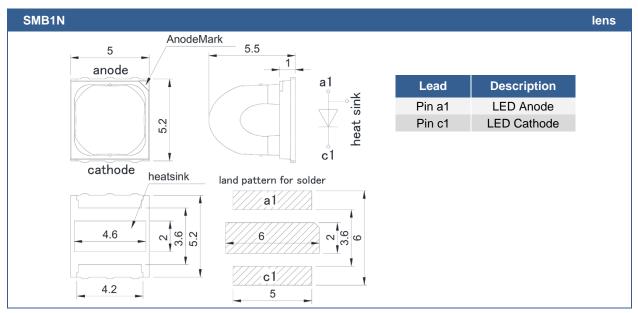








Outline Dimensions



All Dimensions in mm

Precautions

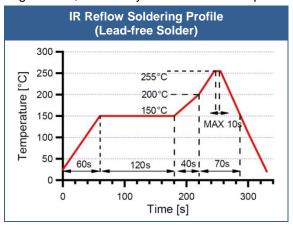
Soldering:

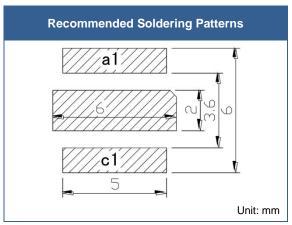
- Do avoid overheating of the LED
- Do avoid electrostatic discharge (ESD)
- Do avoid mechanical stress, shock, and vibration
- Do only use non-corrosive flux
- Do not apply current to the LED until it has cooled down to room temperature after soldering

Recommended soldering conditions:

This LED is designed to be reflow soldered on to a PCB. If dip soldered or hand soldered, its reliability cannot be guarantee.

Nitrogen reflow soldering is recommended. Air flow soldering conditions can cause optical degradation, caused by heat and/or atmosphere.





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Above table specifies the maximum allowed duration and temperature during soldering. It is strongly advised to perform soldering at the shortest time and lowest temperature possible.

Cleaning:

Cleaning with isopropyl alcohol, propanol, or ethyl alcohol is recommended

DO NOT USE acetone, chloroseen, trichloroethylene, or MKS

DO NOT USE ultrasonic cleaners

Static Electricity:

LEDs are sensitive to electrostatic discharge (ESD). Precautions against ESD must be taken when handling or operating these LEDs. Surge voltage or electrostatic discharge can result in complete failure of the device.

Radiation:

During operation these LEDs do emit **high intensity light**, which is hazardous to skin and eyes, and may cause cancer. Do avoid exposure to the emitted light. **Protective glasses are recommended**. It is further advised to attach a warning label on products/systems.

Operation:

Do only operate LEDs with a current source.

Running these LEDs from a voltage source will result in complete failure of the device. Current of a LED is an exponential function of the voltage across it. Usage of current regulated drive circuits is mandatory.

The above specifications are for reference purpose only and subjected to change without prior notice

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